# LN77L GaAlAs Infrared Light Emitting Diode

#### For optical control systems

#### Features

- High-power output, high-efficiency:  $P_0 = 18 \text{ mW}$  (typ.)
- $\bullet$  Fast response and high-speed modulation capability:  $f_{C}$  = 20 MHz (typ.)
- Wide directivity:  $\theta = 20^{\circ}$  (typ.)
- Transparent epoxy resin package

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	190	mW	
Forward current	I <sub>F</sub>	100	mA	
Pulse forward current *	I <sub>FP</sub>	1	Α	
Reverse voltage	V <sub>R</sub>	3	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Note) \*: f = 100 Hz, Duty cycle = 0.1%

#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Radiant power	Po	$I_{\rm F} = 50 \mathrm{mA}$	10	18	7	mW
Reverse current	I <sub>R</sub>	$V_R = 3 V$	N.	ille.	10	μΑ
Forward voltage	VF	$I_{\rm F} = 100 \mathrm{mA}$	S &	1.6	1.9	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 50 \mathrm{mA}$	OS/	860		nm
Spectral half band width	Δλ	$I_{\rm F} = 50 \mathrm{mA}$		40		nm
Half-power angle	θ	The angle when the radiant power is halved.		20		0

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Modulation total power output 3 dB frequency to fall from 1 MHz.

Cutoff frequency: 20 MHz

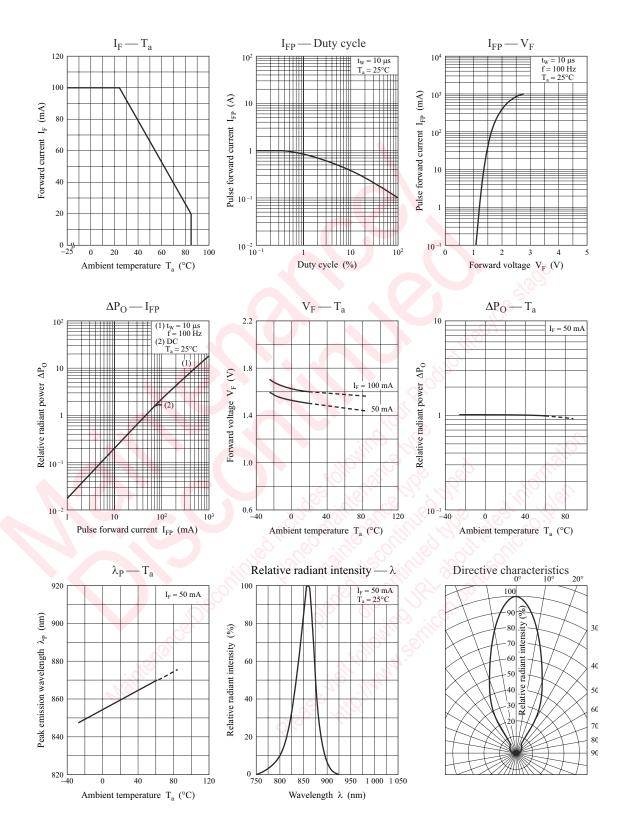
$$f_{\rm C}: 10 \times \log \frac{P_{\rm O} \text{ at } f = f_{\rm C}}{P_{\rm O} \text{ at } f = 1 \text{ MHz}} = -3$$

3. LED might radiate red light under large current drive.

4. \*: A light detection element uses a silicon diode have proofread a load with a standard device.

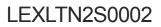
#### LN77L

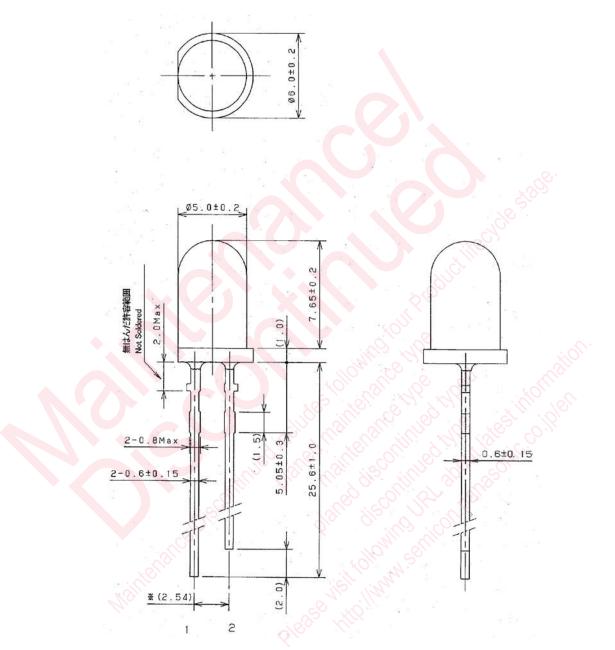
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Package (Unit: mm)





- Pin name
- 1: Anode
- 2: Cathode

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